


TRANSMITTAL

Electronic Version v1.1

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Title of Invention	MULTI-LAYER INTEGRATED SEMICONDUCTOR STRUCTURE HAVING AN ELECTRICAL SHIELDING PORTION	
Application Number :	10/749096	
Date :	2003-12-30	
First Named Applicant:	Reif Rafael	
Confirmation Number:	3177	
Attorney Docket Number:	MIT-136DUS	
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Submitted By:		Elec. Sign.
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